



# SMIC Q3 2017 Financial Presentation

**NYSE: SMI      HKSE: 981**

SMIC Investor Relations

Nov 2017



# Safe Harbor Statements

## Under the Private Securities Litigation Reform Act of 1995

This presentation contains, in addition to historical information, "forward-looking statements" within the meaning of the "safe harbor" provisions of the U.S. Private Securities Litigation Reform Act of 1995. These forward-looking statements, including statements under "Fourth Quarter 2017 Guidance", "CapEx Summary" and the statements contained in the quotes of co-Chief Executive Officers are based on SMIC's current assumptions, expectations and projections about future events. SMIC uses words like "believe," "anticipate," "intend," "estimate," "expect," "project," "target" and similar expressions to identify forward looking statements, although not all forward-looking statements contain these words. These forward-looking statements are necessarily estimates reflecting the best judgment of SMIC's senior management and involve significant risks, both known and unknown, uncertainties and other factors that may cause SMIC's actual performance, financial condition or results of operations to be materially different from those suggested by the forward-looking statements including, among others, risks associated with cyclicity and market conditions in the semiconductor industry, intense competition in the semiconductor industry, SMIC's reliance on a small number of customers, timely wafer acceptance by SMIC's customers, timely introduction of new technologies, SMIC's ability to ramp new products into volume, supply and demand for semiconductor foundry services, industry overcapacity, shortages in equipment, components and raw materials, availability of manufacturing capacity, financial stability in end markets, orders or judgments from pending litigation, intensive intellectual property litigation in semiconductor industry, general economic conditions and fluctuations in currency exchange rates.

In addition to the information contained in this presentation, you should also consider the information contained in our other filings with the SEC, including our annual report on Form 20-F filed with the SEC on April 27, 2017, especially in the "Risk Factors" section and such other documents that we may file with the SEC or The Hong Kong Stock Exchange Limited ("SEHK") from-5(8(l)-(era 31.2723r3s44TBT1 0))5

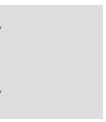


# 3Q17 Financial Highlights

- Revenue was \$770 million
  - Up 2.5% QoQ



# Balance Sheet Highlights



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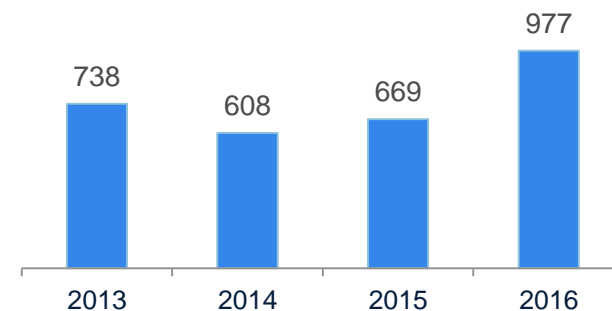
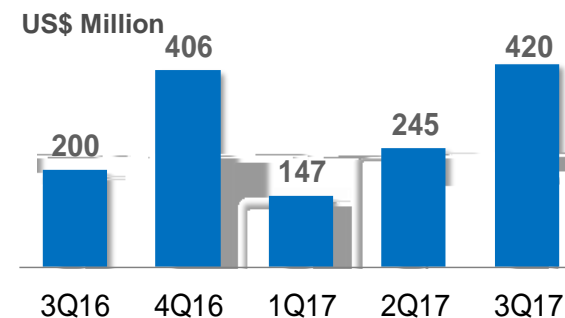
# Cash Flow Highlights

(US\$ thousands)

For the three months ended

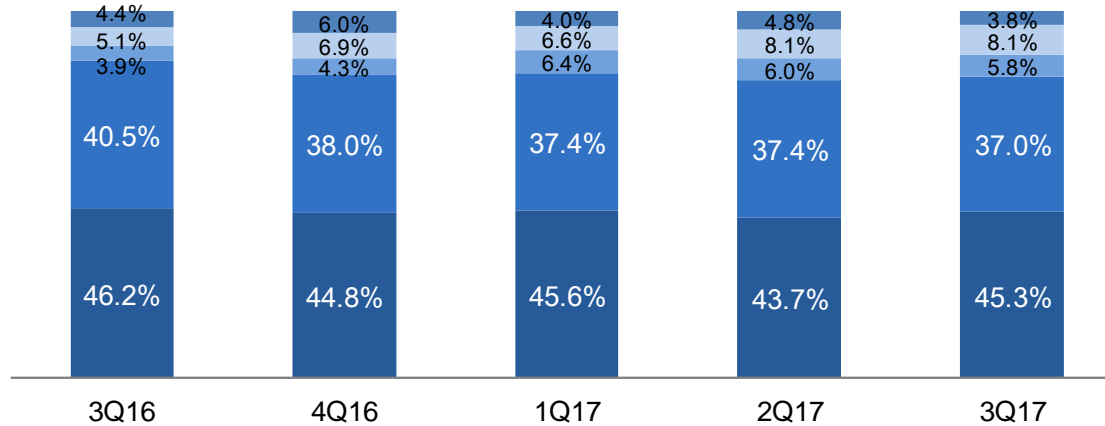
	Sept 30, 2017	June 30, 2017
Cash and cash equivalent, beginning of period	876,118	1,552,043
<b>Net cash from operating activities</b>	<b>419,540</b>	<b>245,219</b>
Net cash used in investing activities	(399,015)	(1,001,407)
Net cash from (used in) financing activities	217,493	80,928
Net increase (decrease) in cash and cash equivalent	243,031	(675,925)
Cash and cash equivalent, end of period	1,119,149	876,118

## Cash Flow from Operations



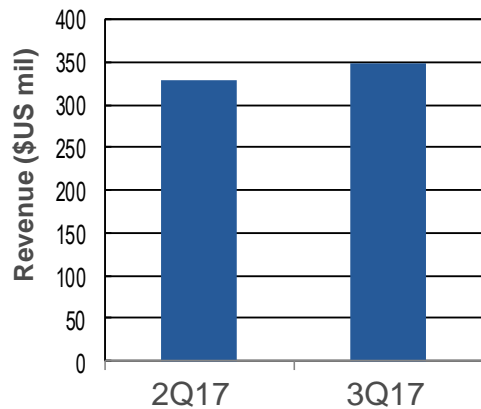
# Total Revenue Breakdown by Applications

■ Communication ■ Consumer ■ Computer ■ Auto/Industrial ■ Others

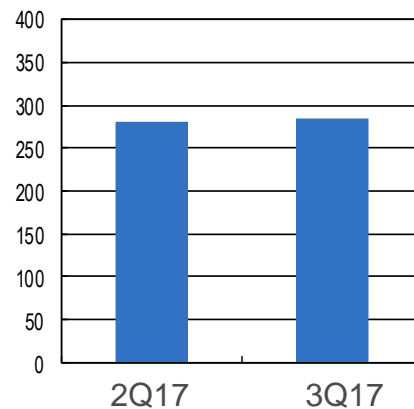


## 3Q17 vs. 2Q17

### Communications



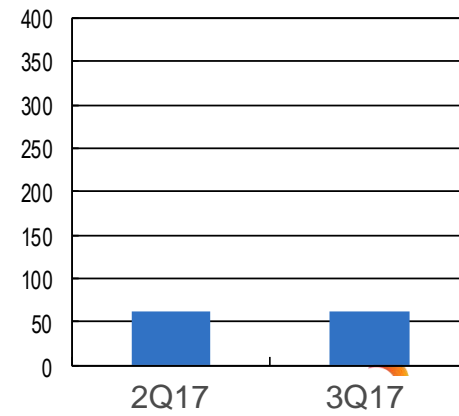
### Consumer



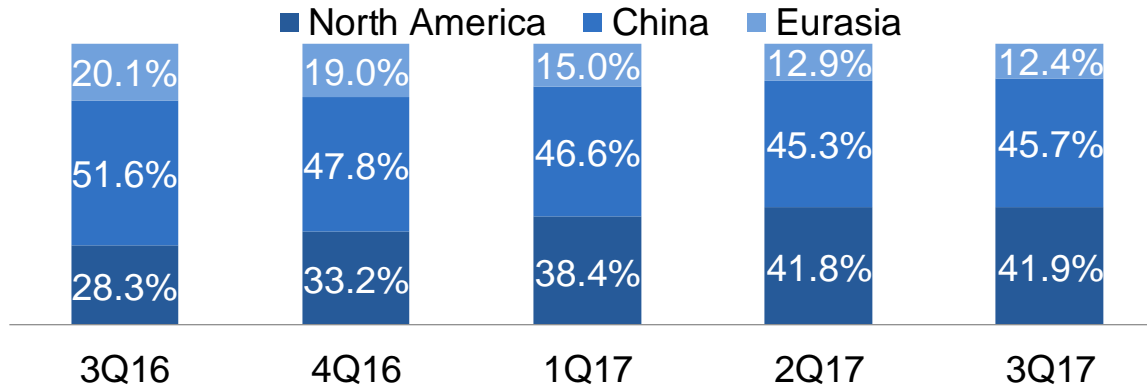
### Computer

2Q17 3Q17

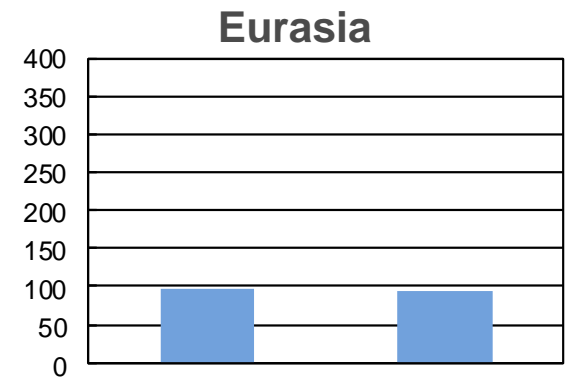
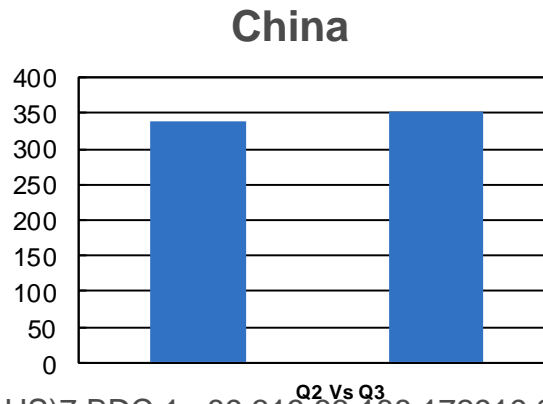
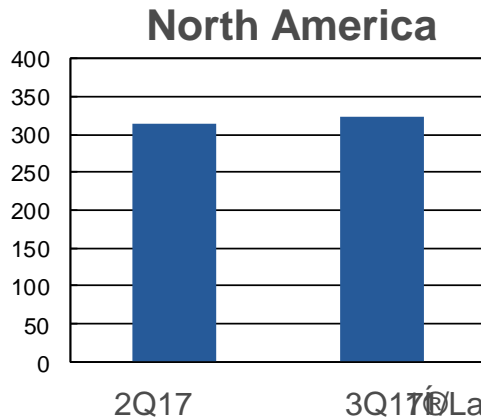
### Auto/Industrial



# Total Revenue Breakdown by Geography



## 3Q17 vs. 2Q17

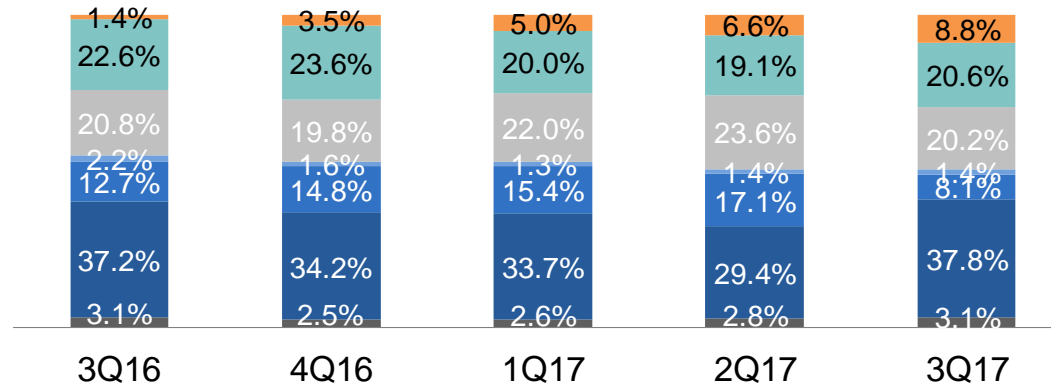


Lang (en-US) > BDC 1 g89.313 33.188 172919.25 ref2 TJ6.691 A MC7D 18/Lang (en-US) > BDC B

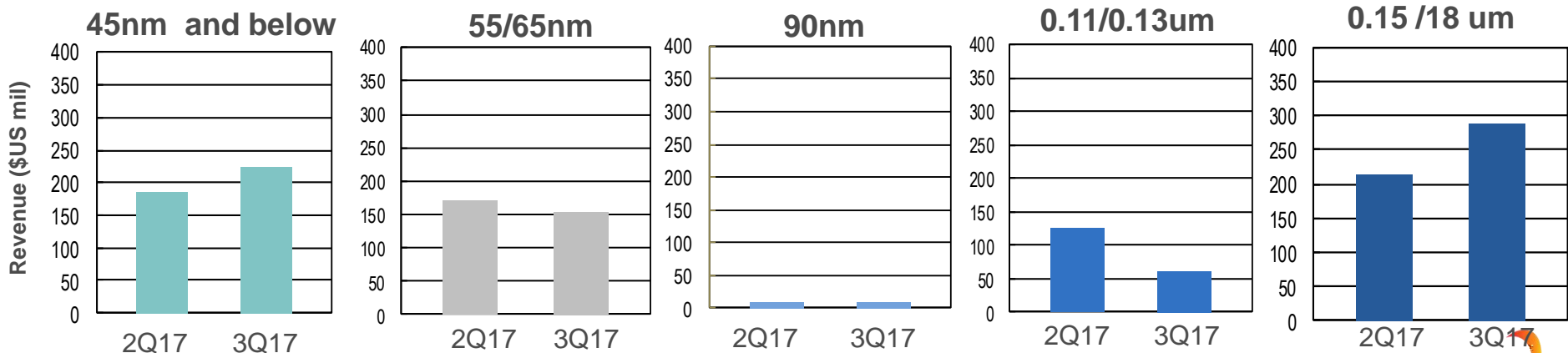


# Wafer Revenue Breakdown by Technology

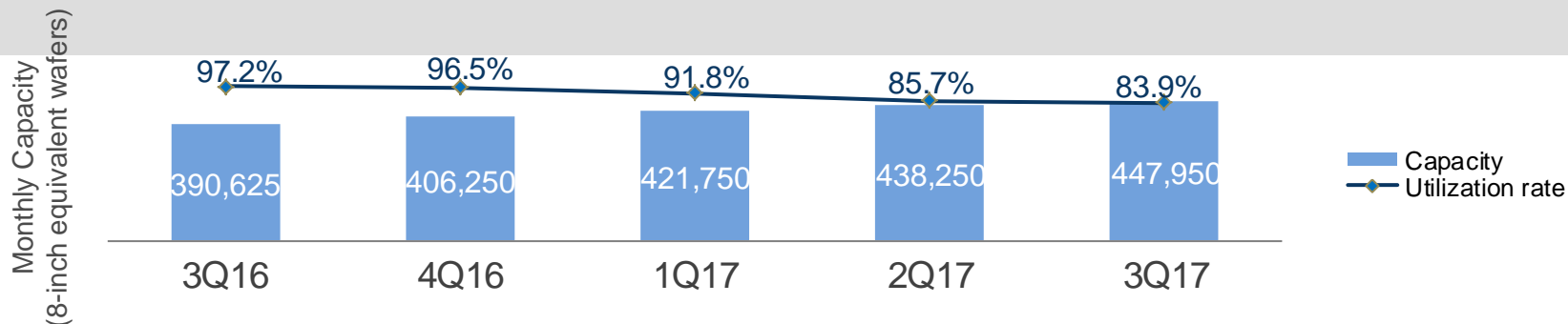
■ 0.25 / 0.35um ■ 0.15 / 0.18um ■ 0.11 / 0.13um ■ 90nm ■ 55 / 65nm ■ 40 / 45nm ■ 28nm



## 3Q 17 vs. 2Q 17



# Capacity, Utilization and Shipment

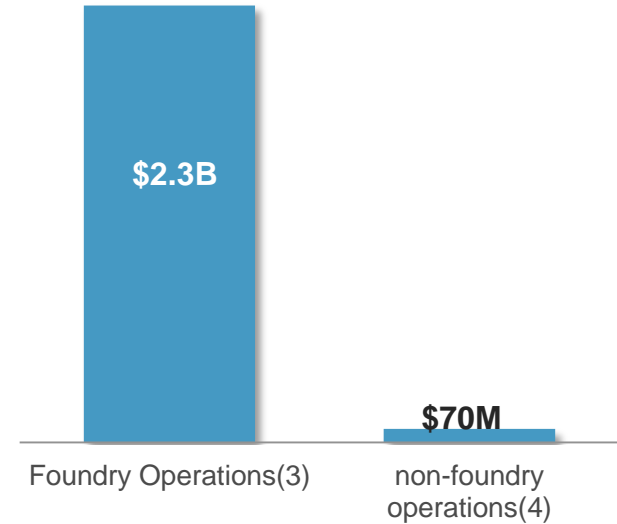


	3Q16	4Q16	1Q17	2Q17	3Q17
Shanghai 200mm Fab	107,000	108,000	110,000	112,000	114,000
Shanghai 300mm Fab	20,000	20,000	20,000	20,000	18,000
Beijing 300mm Fab	39,000	43,000	48,000	50,000	50,000
Tianjin 200mm Fab	45,000	45,000	45,000	45,000	47,000
Shenzhen 200mm Fab	31,000	31,000	31,000	32,000	32,075
Majority-Owned Beijing 300mm Fab	15,500	18,000	19,000	23,000	27,500
Majority-Owned Avezzano 200mm Fab	40,000	40,000	40,000	40,000	40,000
<b>Monthly Capacity (8-inch equivalent wafers)</b>	<b>390,625</b>	<b>406,250</b>	<b>421,750</b>	<b>438,250</b>	<b>447,950</b>
Wafer Shipments	1,058,504	1,096,011	1,095,761	1,014,158	1,076,039

(1) Capacity utilization rate is reported based on total equivalent wafers out divided by estimated total quarterly capacity

## 4Q 2017 Guidance

Revenue	+1% to +3% QoQ \$777 to \$793 million
Gross Margin	18% to 20%
Non-GAAP Operating Expenses <sup>(1)</sup>	\$204 to \$210 million
Non-	

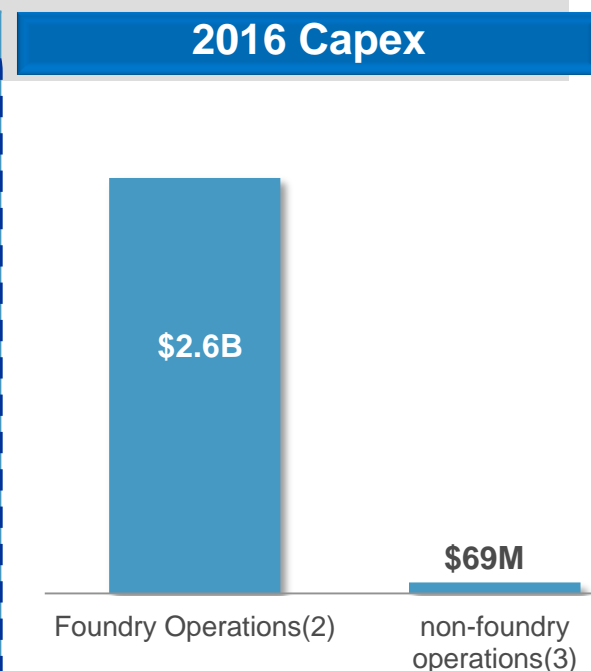




# Appendix

# Results Vs Original Guidance

	3Q 2017 Guidance	3Q 2017 Results
Revenue	flat to +3% QoQ \$751 to \$774 million	+2.5% QoQ \$770 million
Gross Margin	22% to 24%	23.0%
Non-GAAP Operating Expenses (1)	\$179 to \$185 million	\$ 184 million
Non-controlling interests	\$0 to \$3 million	-\$5 million



(1) Exclude the effect of employee bonus accrual, government funding and gain from the disposal of living quarters

(2) The 2016 capital expenditures for foundry operations were \$2,626.2 million, of which \$1,239.7 million was spent for the expansion of capacity in our majority-owned Beijing 300mm fab. The 2016 capital expenditures for non-foundry operations were \$68.5 million primarily for the construction of employees' living quarters.

# Capital Expenditures & Depreciation



<i>(US\$ millions)</i>	3Q16	4Q16	1Q17	2Q17	3Q17
<b>Capex</b>	671	481	727	782	451
<b>Depreciation &amp; Amortization</b>	186	216	235	241	243



# Thank you

Contact us: [ir@smics.com](mailto:ir@smics.com)